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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

E·XFI

Detuns	
Product Status	Active
Core Processor	MIPS32® M4K™
Core Size	32-Bit Single-Core
Speed	40MHz
Connectivity	I ² C, IrDA, LINbus, PMP, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I ² S, POR, PWM, WDT
Number of I/O	53
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 3.6V
Data Converters	A/D 28x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	64-TQFP
Supplier Device Package	64-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic32mx130f128ht-v-pt

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 5: PIN NAMES FOR 100-PIN USB DEVICES (CONTINUED)

10	100-PIN TQFP (TOP VIEW)								
	PIC32MX230F128L PIC32MX530F128L PIC32MX250F256L PIC32MX550F256L PIC32MX270F512L PIC32MX570F512L								
				1					
Pin #	Full Pin Name		Pin #	Full Pin Name					
71	RPD11/PMA14/RD11	1 1	86	VDD					
72	RPD0/INT0/RD0	ĪĪ	87	AN44/C3INA/RPF0/PMD11/RF0					
73	SOSCI/RPC13/RC13	ĪĪ	88	AN45/RPF1/PMD10/RF1					
74	SOSCO/RPC14/T1CK/RC14	t t	89	RPG1/PMD9/RG1					
75	Vss	Ī	90	RPG0/PMD8/RG0					
76	AN24/RPD1/RD1	11	91	RA6					
77	AN25/RPD2/RD2	11	92	CTED8/RA7					
78	AN26/C3IND/RPD3/RD3] [93	AN46/PMD0/RE0					
79	AN40/RPD12/PMD12/RD12	[94	AN47/PMD1/RE1					
80	AN41/PMD13/RD13	[95	RG14					
81	RPD4/PMWR/RD4	[96	RG12					
82	RPD5/PMRD/RD5	[97	RG13					
83	AN42/C3INC/PMD14/RD6] [98	AN20/PMD2/RE2					
84	AN43/C3INB/PMD15/RD7	[99	RPE3/CTPLS/PMD3/RE3					
85	VCAP	[100	AN21/PMD4/RE4					

Note 1: The RPn pins can be used by remappable peripherals. See Table 1 for the available peripherals and Section 11.3 "Peripheral Pin Select" for restrictions.

2: Every I/O port pin (RAx-RGx) can be used as a change notification pin (CNAx-CNGx). See Section 11.0 "I/O Ports" for more information.

3: Shaded pins are 5V tolerant.

NOTES:

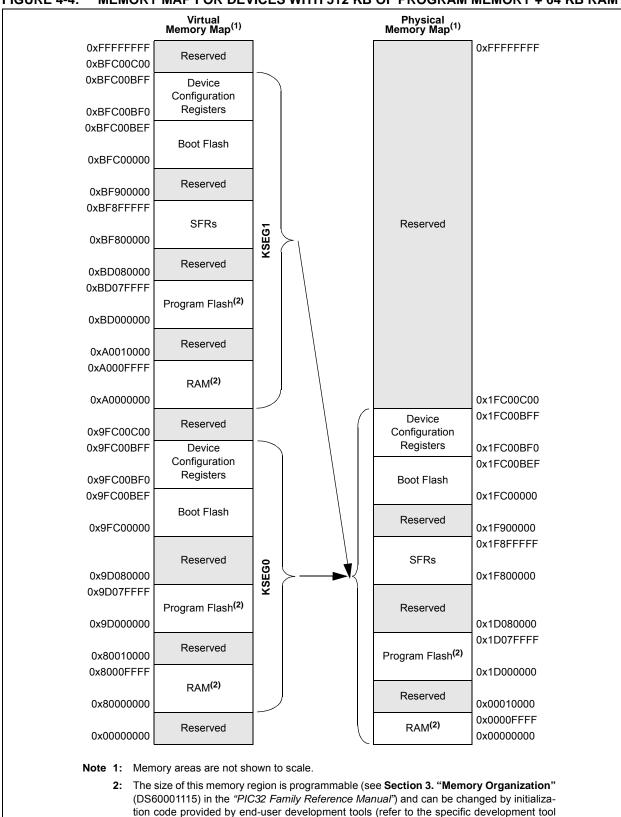


FIGURE 4-4: MEMORY MAP FOR DEVICES WITH 512 KB OF PROGRAM MEMORY + 64 KB RAM

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documentation for information).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0		
04.04	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0		
31:24	NVMKEY<31:24>									
00.40	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0		
23:16		NVMKEY<23:16>								
45.0	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0		
15:8	15:8 NVMKEY<15:8>									
7.0	W-0	W-0	W-0	W-0	W-0	W-0	W-0	W-0		
7:0	NVMKEY<7:0>									

REGISTER 6-2: NVMKEY: PROGRAMMING UNLOCK REGISTER

Legend:

Logona.				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-0 **NVMKEY<31:0>:** Unlock Register bits These bits are write-only, and read as '0' on any read.

Note: This register is used as part of the unlock sequence to prevent inadvertent writes to the PFM.

REGISTER 6-3: NVMADDR: FLASH ADDRESS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
24.24	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
31:24	NVMADDR<31:24>								
22:46	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
23:16	NVMADDR<23:16>								
45.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
15:8	NVMADDR<15:8>								
7.0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
7:0	NVMADDR<7:0>								

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-0 NVMADDR<31:0>: Flash Address bits Bulk/Chip/PFM Erase: Address is ignored Page Erase: Address identifies the page to erase Row Program: Address identifies the row to program Word Program: Address identifies the word to program

REGISTE	REGISTER 9-8: DCHXECON: DMA CHANNEL 'x' EVENT CONTROL REGISTER								
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0	
31.24	—	—	—	—	—	—	_	—	
22:16	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
23:16	CHAIRQ<7:0> ⁽¹⁾								
15:0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1	
15:8	CHSIRQ<7:0> ⁽¹⁾								
7:0	S-0	S-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	
7.0	CFORCE	CABORT	PATEN	SIRQEN	AIRQEN	_			

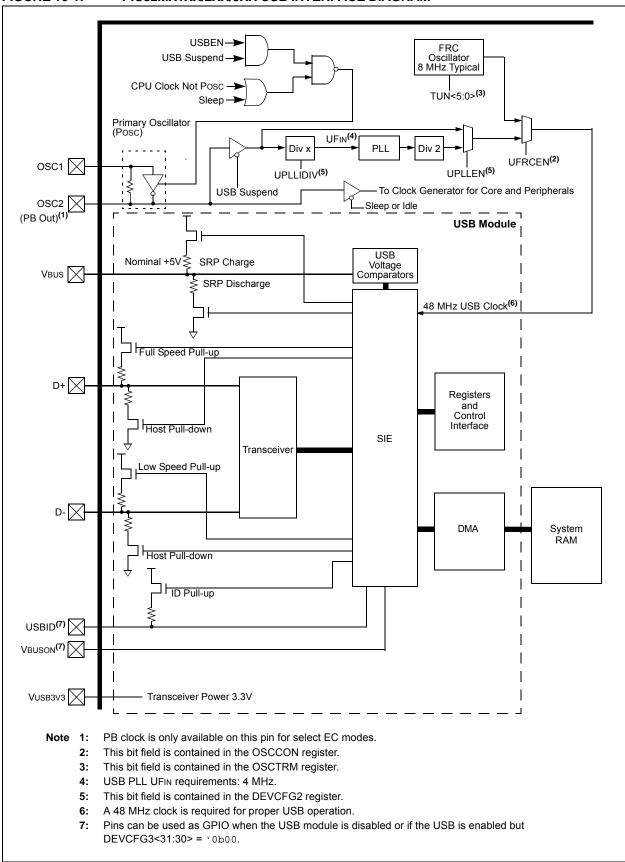
Legend:	S = Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-24 **~** d · ~ '

bit 31-24	Unimplemented: Read as '0'
bit 23-16	CHAIRQ<7:0>: Channel Transfer Abort IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will abort any transfers in progress and set CHAIF flag
	•
	•
	•
	00000001 = Interrupt 1 will abort any transfers in progress and set CHAIF flag
	00000000 = Interrupt 0 will abort any transfers in progress and set CHAIF flag
bit 15-8	CHSIRQ<7:0>: Channel Transfer Start IRQ bits ⁽¹⁾
	11111111 = Interrupt 255 will initiate a DMA transfer
	•
	•
	•
	00000001 = Interrupt 1 will initiate a DMA transfer
	0000000 = Interrupt 0 will initiate a DMA transfer
bit 7	CFORCE: DMA Forced Transfer bit
	1 = A DMA transfer is forced to begin when this bit is written to a '1'
	0 = This bit always reads '0'
bit 6	CABORT: DMA Abort Transfer bit
	1 = A DMA transfer is aborted when this bit is written to a '1'
	0 = This bit always reads '0'
bit 5	PATEN: Channel Pattern Match Abort Enable bit
	1 = Abort transfer and clear CHEN on pattern match
	2 Dettern weetsk is dischlad

- 0 = Pattern match is disabled
- bit 4 SIRQEN: Channel Start IRQ Enable bit
 - 1 = Start channel cell transfer if an interrupt matching CHSIRQ occurs
 - 0 = Interrupt number CHSIRQ is ignored and does not start a transfer
- bit 3 AIRQEN: Channel Abort IRQ Enable bit
 - 1 = Channel transfer is aborted if an interrupt matching CHAIRQ occurs
 - 0 = Interrupt number CHAIRQ is ignored and does not terminate a transfer
- bit 2-0 Unimplemented: Read as '0'
- Note 1: See Table 5-1: "Interrupt IRQ, Vector and Bit Location" for the list of available interrupt IRQ sources.

NOTES:



REGISTER 10-10: U1STAT: USB STATUS REGISTER

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
31:24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31.24	_	_			—		_	—
23:16	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23.10		_			—			_
15:8	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
10.0	_	_			—		_	—
7:0	R-x	R-x	R-x	R-x	R-x	R-x	U-0	U-0
7.0		ENDP	T<3:0>		DIR	PPBI		—

Legend:

R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-8 Unimplemented: Read as '0'

- bit 7-4 **ENDPT<3:0>:** Encoded Number of Last Endpoint Activity bits (Represents the number of the BDT, updated by the last USB transfer.)
 - 1111 = Endpoint 15 1110 = Endpoint 14 . . 0001 = Endpoint 1 0000 = Endpoint 0
- bit 3 **DIR:** Last BD Direction Indicator bit
 - 1 = Last transaction was a transmit transfer (TX)
 - 0 = Last transaction was a receive transfer (RX)
- bit 2 PPBI: Ping-Pong BD Pointer Indicator bit
 - 1 = The last transaction was to the ODD BD bank
 - 0 = The last transaction was to the EVEN BD bank
- bit 1-0 Unimplemented: Read as '0'

Note: The U1STAT register is a window into a 4-byte FIFO maintained by the USB module. U1STAT value is only valid when the TRNIF bit (U1IR<3>) is active. Clearing the TRNIF bit advances the FIFO. Data in register is invalid when the TRNIF bit = 0.

11.3 Peripheral Pin Select

A major challenge in general purpose devices is providing the largest possible set of peripheral features while minimizing the conflict of features on I/O pins. The challenge is even greater on low pin count devices. In an application where more than one peripheral needs to be assigned to a single pin, inconvenient workarounds in application code or a complete redesign may be the only options.

Peripheral pin select configuration provides an alternative to these choices by enabling peripheral set selection and their placement on a wide range of I/O pins. By increasing the pinout options available on a particular device, users can better tailor the device to their entire application, rather than trimming the application to fit the device.

The peripheral pin select configuration feature operates over a fixed subset of digital I/O pins. Users may independently map the input and/or output of most digital peripherals to these I/O pins. Peripheral pin select is performed in software and generally does not require the device to be reprogrammed. Hardware safeguards are included that prevent accidental or spurious changes to the peripheral mapping once it has been established.

11.3.1 AVAILABLE PINS

The number of available pins is dependent on the particular device and its pin count. Pins that support the peripheral pin select feature include the designation "RPn" in their full pin designation, where "RP" designates a remappable peripheral and "n" is the remappable port number.

11.3.2 AVAILABLE PERIPHERALS

The peripherals managed by the peripheral pin select are all digital-only peripherals. These include general serial communications (UART and SPI), general purpose timer clock inputs, timer-related peripherals (input capture and output compare) and interrupt-on-change inputs.

In comparison, some digital-only peripheral modules are never included in the peripheral pin select feature. This is because the peripheral's function requires special I/O circuitry on a specific port and cannot be easily connected to multiple pins. These modules include I²C among others. A similar requirement excludes all modules with analog inputs, such as the Analog-to-Digital Converter (ADC).

A key difference between remappable and non-remappable peripherals is that remappable peripherals are not associated with a default I/O pin. The peripheral must always be assigned to a specific I/O pin before it can be used. In contrast, non-remappable peripherals are always available on a default pin, assuming that the peripheral is active and not conflicting with another peripheral. When a remappable peripheral is active on a given I/O pin, it takes priority over all other digital I/O and digital communication peripherals associated with the pin. Priority is given regardless of the type of peripheral that is mapped. Remappable peripherals never take priority over any analog functions associated with the pin.

11.3.3 CONTROLLING PERIPHERAL PIN SELECT

Peripheral pin select features are controlled through two sets of SFRs: one to map peripheral inputs, and one to map outputs. Because they are separately controlled, a particular peripheral's input and output (if the peripheral has both) can be placed on any selectable function pin without constraint.

The association of a peripheral to a peripheral-selectable pin is handled in two different ways, depending on whether an input or output is being mapped.

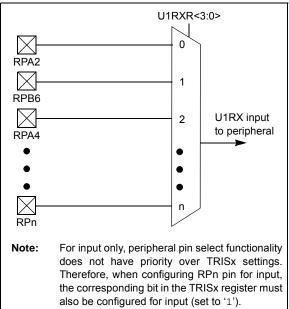
11.3.4 INPUT MAPPING

The inputs of the peripheral pin select options are mapped on the basis of the peripheral. That is, a control register associated with a peripheral dictates the pin it will be mapped to. The [*pin name*]R registers, where [*pin name*] refers to the peripheral pins listed in Table 11-1, are used to configure peripheral input mapping (see Register 11-1). Each register contains sets of 4 bit fields. Programming these bit fields with an appropriate value maps the RPn pin with the corresponding value to that peripheral. For any given device, the valid range of values for any bit field is shown in Table 11-1.

For example, Figure 11-2 illustrates the remappable pin selection for the U1RX input.

FIGURE 11-2: REI

REMAPPABLE INPUT EXAMPLE FOR U1RX



Peripheral Pin	[pin name]R SFR	[pin name]R bits	[<i>pin name</i>]R Value to RPn Pin Selection
INT1	INT1R	INT1R<3:0>	0000 = RPD1 0001 = RPG9
тзск	T3CKR	T3CKR<3:0>	0010 = RPB14 0011 = RPD0
IC1	IC1R	IC1R<3:0>	0100 = RPD8 0101 = RPB6
U3CTS	U3CTSR	U3CTSR<3:0>	0110 = RPD5 0111 = RPB2
U4RX	U4RXR	U4RXR<3:0>	1000 = RPF3 ⁽⁴⁾ 1001 = RPF13 ⁽³⁾
U5RX	U5RXR	U5RXR<3:0>	1010 = Reserved 1011 = RPF2 ⁽¹⁾
SS2	SS2R	SS2R<3:0>	1100 = RPC2 ⁽³⁾ 1101 = RPE8 ⁽³⁾
OCFA	OCFAR	OCFAR<3:0>	1110 = Reserved 1111 = Reserved

TABLE 11-1:INPUT PIN SELECTION (CONTINUED)

Note 1: This selection is not available on 64-pin USB devices.

- 2: This selection is only available on 100-pin General Purpose devices.
- 3: This selection is not available on 64-pin devices.
- 4: This selection is not available when USBID functionality is used on USB devices.
- 5: This selection is not available on devices without a CAN module.
- 6: This selection is not available on USB devices.
- 7: This selection is not available when VBUSON functionality is used on USB devices.

12.0 TIMER1

Note: This data sheet summarizes the features of the PIC32MX1XX/2XX/5XX 64/100-pin family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 14. "Timers"** (DS60001105) in the *"PIC32 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com/PIC32). This family of PIC32 devices features one synchronous/ asynchronous 16-bit timer that can operate as a freerunning interval timer for various timing applications and counting external events. This timer can also be used with the Low-Power Secondary Oscillator (Sosc) for Real-Time Clock (RTC) applications. The following modes are supported:

- Synchronous Internal Timer
- Synchronous Internal Gated Timer
- Synchronous External Timer
- Asynchronous External Timer

12.1 Additional Supported Features

- · Selectable clock prescaler
- Timer operation during CPU Idle and Sleep mode
- Fast bit manipulation using CLR, SET and INV registers
- Asynchronous mode can be used with the Sosc to function as a Real-Time Clock (RTC)

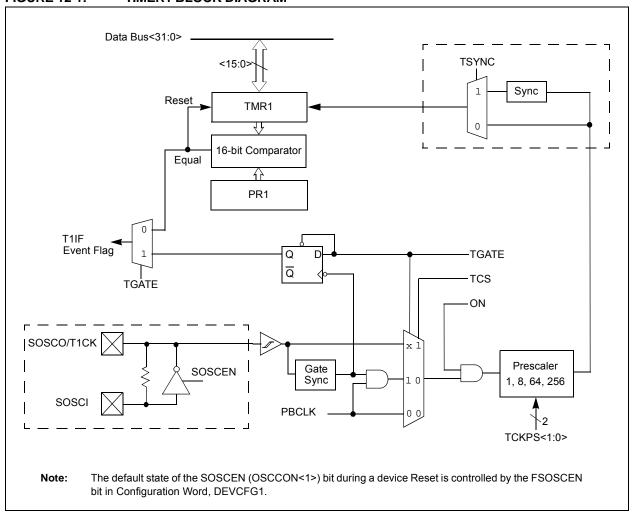


FIGURE 12-1: TIMER1 BLOCK DIAGRAM

NOTES:

REGIST	ER 21-2: RTCALRM: RTC ALARM CONTROL REGISTER (CONTINUED)
bit 7-0	ARPT<7:0>: Alarm Repeat Counter Value bits ⁽³⁾
	11111111 =Alarm will trigger 256 times
	•
	•
	• 00000000 =Alarm will trigger one time
	The counter decrements on any alarm event. The counter only rolls over from 0x00 to 0xFF if CHIME = 1.
Note 1:	Hardware clears the ALRMEN bit anytime the alarm event occurs, when ARPT<7:0> = 00 and CHIME = 0 .
2:	This field should not be written when the RTCC ON bit = '1' (RTCCON<15>) and ALRMSYNC = 1.
3:	This assumes a CPU read will execute in less than 32 PBCLKs.
Note:	This register is reset only on a Power-on Reset (POR).

REGISTER 21-4. RTCDATE, RTC DATE VALUE REGISTER									
Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
31:24		YEAR1	0<3:0>			YEAR0	1<3:0>		
23:16	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
23:16		MONTH	10<3:0>		MONTH01<3:0>				
	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	
15:8		DAY10	<3:0>			DAY01<3:0>			
7.0	U-0	U-0	U-0	U-0	R/W-x	R/W-x	R/W-x	R/W-x	
7:0	_	—	—	—	— WDAY01<3:0			·	
		•							
Legend:									
R = Readable bit W = Wr				e bit	U = Unimple	emented bit, re	ead as '0'		
-n = Value	e at POR		•			x = Bit is un	known		

REGISTER 21-4: RTCDATE: RTC DATE VALUE REGISTER

bit 31-28 YEAR10<3:0>: Binary-Coded Decimal Value of Years bits, 10s place digits

bit 27-24 YEAR01<3:0>: Binary-Coded Decimal Value of Years bits, 1s place digit

bit 23-20 MONTH10<3:0>: Binary-Coded Decimal Value of Months bits, 10s place digits; contains a value of 0 or 1

bit 19-16 MONTH01<3:0>: Binary-Coded Decimal Value of Months bits, 1s place digit; contains a value from 0 to 9

bit 15-12 DAY10<3:0>: Binary-Coded Decimal Value of Days bits, 10s place digits; contains a value from 0 to 3

bit 11-8 **DAY01<3:0>:** Binary-Coded Decimal Value of Days bits, 1s place digit; contains a value from 0 to 9

bit 7-4 Unimplemented: Read as '0'

bit 3-0 WDAY01<3:0>: Binary-Coded Decimal Value of Weekdays bits,1s place digit; contains a value from 0 to 6

Note: This register is only writable when RTCWREN = 1 (RTCCON<3>).

Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
24.24	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
31:24		—	_	_	—		_	_
00.40	U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
23:16	—	—	_	-	—	_	_	_
45.0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
15:8	ON ⁽¹⁾	_	_	_	_	_	_	_
7.0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
7:0	_	CVROE	CVRR	CVRSS		CVR<	<3:0>	

REGISTER 25-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, r	ead as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 31-16 Unimplemented: Read as '0'

- bit 15 **ON:** Comparator Voltage Reference On bit⁽¹⁾
 - 1 = Module is enabled
 - Setting this bit does not affect other bits in the register.
 - 0 = Module is disabled and does not consume current
 - Clearing this bit does not affect the other bits in the register.
- bit 14-7 Unimplemented: Read as '0'
- bit 6 **CVROE:** CVREFOUT Enable bit
 - 1 = Voltage level is output on CVREFOUT pin
 - 0 = Voltage level is disconnected from CVREFOUT pin
- bit 5 **CVRR:** CVREF Range Selection bit
 - 1 = 0 to 0.625 CVRSRC, with CVRSRC/24 step size
 - $_{\rm 0}$ = 0.25 CVRsRc to 0.719 CVRsRc, with CVRsRc/32 step size
- bit 4 **CVRSS:** CVREF Source Selection bit
 - 1 = Comparator voltage reference source, CVRSRC = (VREF+) (VREF-)
 - 0 = Comparator voltage reference source, CVRSRC = AVDD AVSS
- bit 3-0 **CVR<3:0>:** CVREF Value Selection $0 \le CVR<3:0> \le 15$ bits
 - $\frac{\text{When CVRR = 1:}}{\text{CVREF = (CVR<3:0>/24) \bullet (CVRSRC)}}$ $\frac{\text{When CVRR = 0:}}{\text{CVREF = 1/4 \bullet (CVRSRC) + (CVR<3:0>/32) \bullet (CVRSRC)}}$
 - **Note 1:** When using 1:1 PBCLK divisor, the user's software should not read/write the peripheral's SFRs in the SYSCLK cycle immediately following the instruction that clears the module's ON bit.

26.0 CHARGE TIME MEASUREMENT UNIT (CTMU)

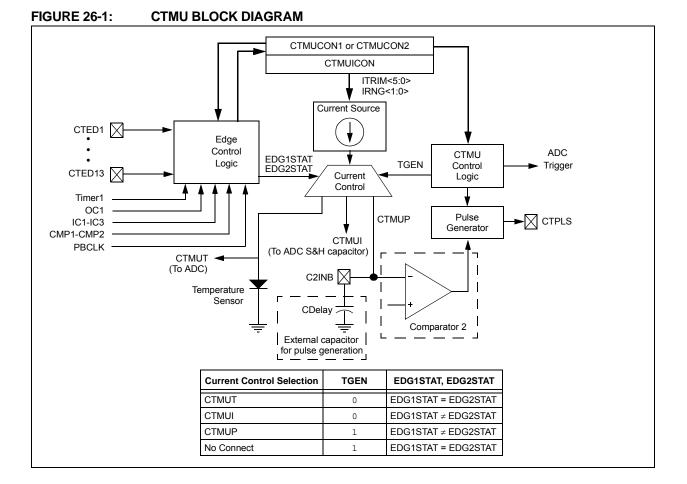
Note: This data sheet summarizes the features of the PIC32MX1XX/2XX/5XX 64/100-pin family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to Section 37. "Charge Time Measurement Unit (CTMU)" (DS60001167) in the "PIC32 Family Reference Manual", which is available the site from Microchip web (www.microchip.com).

The Charge Time Measurement Unit (CTMU) is a flexible analog module that has a configurable current source with a digital configuration circuit built around it. The CTMU can be used for differential time measurement between pulse sources and can be used for generating an asynchronous pulse. By working with other on-chip analog modules, the CTMU can be used for high resolution time measurement, measure capacitance, measure relative changes in capacitance or generate output pulses with a specific time delay. The CTMU is ideal for interfacing with capacitive-based sensors.

The CTMU module includes the following key features:

- Up to 13 channels available for capacitive or time measurement input
- · On-chip precision current source
- 16-edge input trigger sources
- · Selection of edge or level-sensitive inputs
- Polarity control for each edge source
- Control of edge sequence
- Control of response to edges
- · High precision time measurement
- Time delay of external or internal signal asynchronous to system clock
- · Integrated temperature sensing diode
- · Control of current source during auto-sampling
- Four current source ranges
- · Time measurement resolution of one nanosecond

A block diagram of the CTMU is shown in Figure 26-1.



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Bit Range	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0	
04.04	r-1	r-1	r-1	r-1	r-1	r-1	R/P	R/P	
31:24	—	—	—	-	—	_	FWDTWI	NSZ<1:0>	
00.40	R/P	R/P	r-1	R/P	R/P	R/P	R/P	R/P	
23:16	FWDTEN	WINDIS	—	WDTPS<4:0>					
45.0	R/P	R/P	R/P	R/P	r-1	R/P	R/P	R/P	
15:8	FCKSM	/<1:0>	FPBDI	V<1:0>	—	OSCIOFNC	POSCM	OD<1:0>	
7.0	R/P	r-1	R/P	r-1	r-1	R/P	R/P	R/P	
7:0	IESO	—	FSOSCEN			F	NOSC<2:0>		

REGISTER 28-2: DEVCFG1: DEVICE CONFIGURATION WORD 1

Legend:	r = Reserved bit	P = Programmable bit		
R = Readable bit	W = Writable bit	le bit U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown	

bit 31-26 Reserved: Write '1'

bit 25-24 **FWDTWINSZ:** Watchdog Timer Window Size bits

- 11 = Window size is 25%
- 10 = Window size is 37.5%
- 01 = Window size is 50%
- 00 = Window size is 75%

bit 23 FWDTEN: Watchdog Timer Enable bit

- 1 = Watchdog Timer is enabled and cannot be disabled by software
- 0 = Watchdog Timer is not enabled; it can be enabled in software

bit 22 WINDIS: Watchdog Timer Window Enable bit

- 1 = Watchdog Timer is in non-Window mode
- 0 = Watchdog Timer is in Window mode
- bit 21 Reserved: Write '1'

bit 20-16 WDTPS<4:0>: Watchdog Timer Postscale Select bits

~	
	10100 = 1:1048576
	10011 = 1:524288
	10010 = 1:262144
	10001 = 1:131072
	10000 = 1:65536
	01111 = 1:32768
	01110 = 1:16384
	01101 = 1:8192
	01100 = 1:4096
	01011 = 1:2048
	01010 = 1:1024
	01001 = 1:512
	01000 = 1:256
	00111 = 1:128
	00110 = 1:64
	00101 = 1:32
	00100 = 1:16
	00011 = 1 :8
	00010 = 1 :4
	00001 = 1:2
	00000 = 1:1
	All other combinations not shown result in operation = 10100
	· ·

Note 1: Do not disable the Posc (POSCMOD = 11) when using this oscillator source.

DC CHARACTERISTICS				dard Operating Conditions: 2.3V to 3.6V (unless otherwise stated) ating temperature $-40^{\circ}C \le TA \le +85^{\circ}C$ for Industrial $-40^{\circ}C \le TA \le +105^{\circ}C$ for V-temp					
Param. No.	Typical ⁽²⁾	Max.	Units	Conditions					
Power-Down Current (IPD) (Notes 1, 5)									
DC40k	33	78	μA	-40°C					
DC40I	49	78	μA	+25°C	Base Power-Down Current				
DC40n	281	450	μA	+85°C	Base Fower-Down Current				
DC40m	559	895	μA	+105°C					
Module	Differential	Current							
DC41e	10	25	μA	3.6V	Watchdog Timer Current: AIWDT (Note 3)				
DC42e	29	50	μA	3.6V	RTCC + Timer1 w/32 kHz Crystal: ΔIRTCC (Note 3)				
DC43d	1000	1300	μA	3.6V ADC: ∆IADC (Notes 3,4)					

TABLE 31-7: DC CHARACTERISTICS: POWER-DOWN CURRENT (IPD)

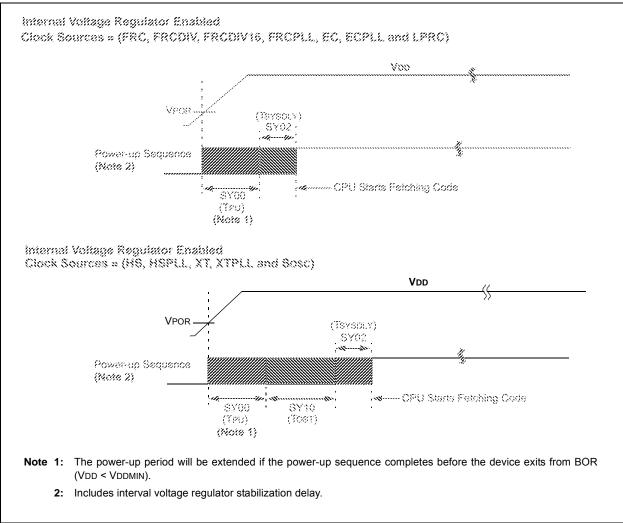
Note 1: The test conditions for IPD current measurements are as follows:

Oscillator mode is EC (for 8 MHz and below) and EC+PLL (for above 8 MHz) with OSC1 driven by external square wave from rail-to-rail, (OSC1 input clock input over/undershoot < 100 mV required)

OSC2/CLKO is configured as an I/O input pin

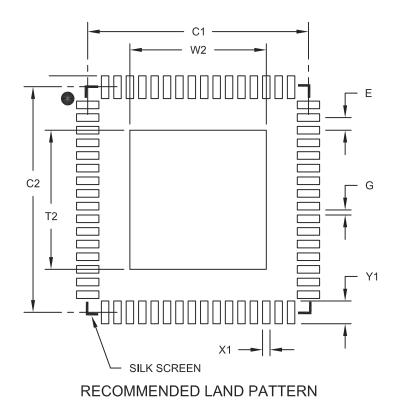
- USB PLL oscillator is disabled if the USB module is implemented, PBCLK divisor = 1:8
- CPU is in Sleep mode, and SRAM data memory Wait states = 1
- No peripheral modules are operating, (ON bit = 0), but the associated PMD bit is set
- WDT, Clock Switching, Fail-Safe Clock Monitor, and Secondary Oscillator are disabled
- All I/O pins are configured as inputs and pulled to Vss
- MCLR = VDD
- RTCC and JTAG are disabled
- 2: Data in the "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- **3:** The ∆ current is the additional current consumed when the module is enabled. This current should be added to the base IPD current.
- 4: Test conditions for ADC module differential current are as follows: Internal ADC RC oscillator enabled.
- 5: IPD electrical characteristics for devices with 256 KB Flash are only provided as Preliminary information.

FIGURE 31-4: POWER-ON RESET TIMING CHARACTERISTICS



64-Lead Plastic Quad Flat, No Lead Package (MR) – 9x9x0.9 mm Body [QFN] With 0.40 mm Contact Length and 5.40x5.40mm Exposed Pad

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS			
Dimensior	Dimension Limits			MAX
Contact Pitch	Contact Pitch E			
Optional Center Pad Width	Nidth W2 5.			5.50
Optional Center Pad Length	T2			5.50
Contact Pad Spacing	C1		8.90	
Contact Pad Spacing	C2		8.90	
Contact Pad Width (X64)	X1			0.30
Contact Pad Length (X64)	Y1			0.85
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2154A